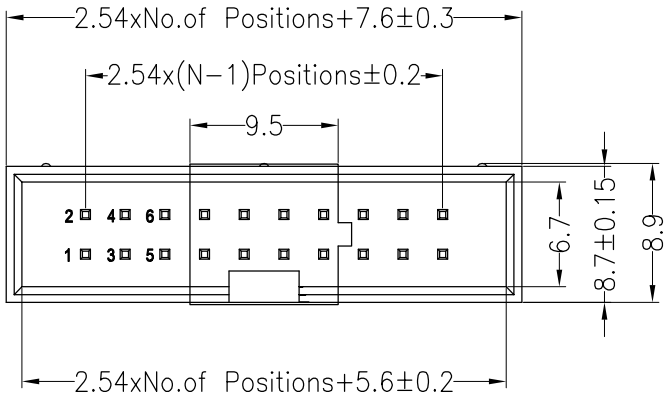
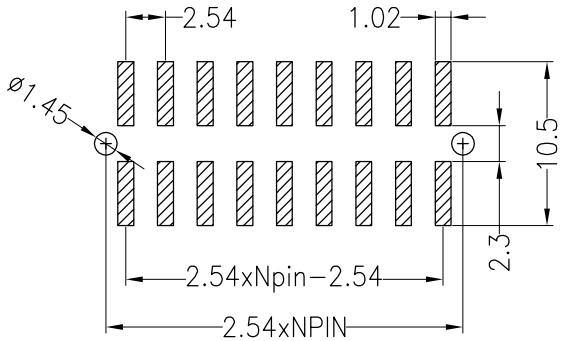
HSF RoHS FILE NO:E362810

SPECIFICATIONS
Rated Current:3.0AMP
Contact Resistance:20mΩ Max
Withstand Voltage:1000V AC/DC
Insulation Resistance:1000MΩ Min
Operation Temperature:−40°c to +105°c

Contact Material:Brass
Contact Plating:Au or Sn Over Ni
Insulator Material:Polyester(UL94V−0)
Standard: PA6T
Max.Processing Temp: 230°C for 30−60 seconds
(260°C for 10 seconds)



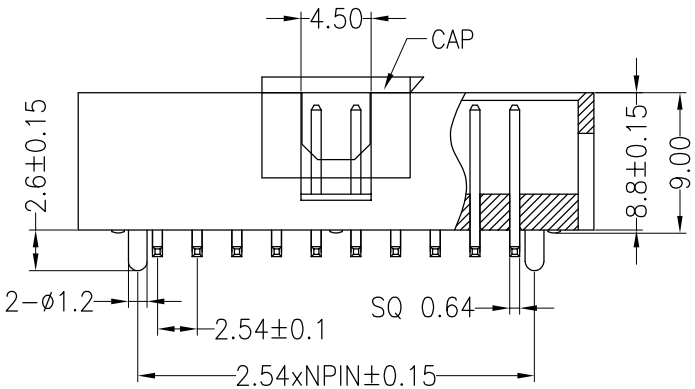
Recommended P.C.B Layout(Top Side)
(PCB BOARD TOLERANCE±0.05)

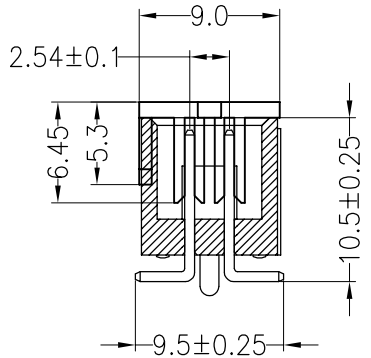


Ordering Information

3210 XX M XX X B K00 X 0X

No.of Pins	Contact Plating	Insulator Material	Packing
6−−64	G0:Gold Flash G1:1U" Gold G2:1.5U" Gold G3:2U" Gold G4:3U" Gold G5:5U" Gold S0:Gold Flash/Tin SN:Tin	Option C=PA6T D=PA46 E=PA9T F=LCP	0=PE Bag A=Tray T=Tube P=Tube+Cap R=Reel+Cap





REV	DATE	MODIFICATION DESCRIPTION	CHANGE
A0	2018.03.28	NEW DRAWING	

OPERATION		DRAW	Liu Miao	18.03.28	SCALE	FIT
X.X	±0.30				UNIT	mm
X.XX	±0.20	CHECK			SIZE	A4
X.XXX	±0.10				SHEET	1/1
Angle	±3°	APPROVE			PROJ.	
DIM	TOL					

WFD CONN 深圳市旺富达电子有限公司 SHEN ZHEN WFD ELECTRONICS CO., LTD

PART NO.	3210XXMXXXBK0X0X
TITLE:	2.54mm Box Header H8.8mm SMT 外柱